

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Kovarsky, et al.

Serial No.: 10/690,408

Filed: October 21, 2003

Confirmation No.: 7371

**For: Copper Replenishment For
 Copper Plating With
 Insoluble Anode**

Group Art Unit: 1742

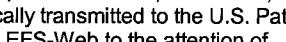
Examiner: Harry D. Wilkins, III

MAILSTOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or electronically transmitted to the U.S. Patent and Trademark Office via EFS-Web to the attention of Examiner Wilkins, on the date shown below.

October 4, 2006


Steven H VerSteeg

RESPONSE TO FINAL OFFICE ACTION DATED JULY 12, 2006

In response to the Final Office Action dated July 12, 2006, having a shortened statutory period for response set to expire on October 12, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/008541/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 5 of this paper.